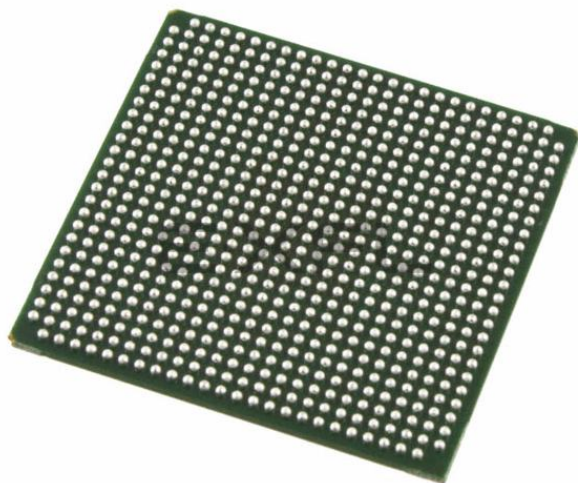




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	396288
Number of I/O	500
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-50e-5f672i

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

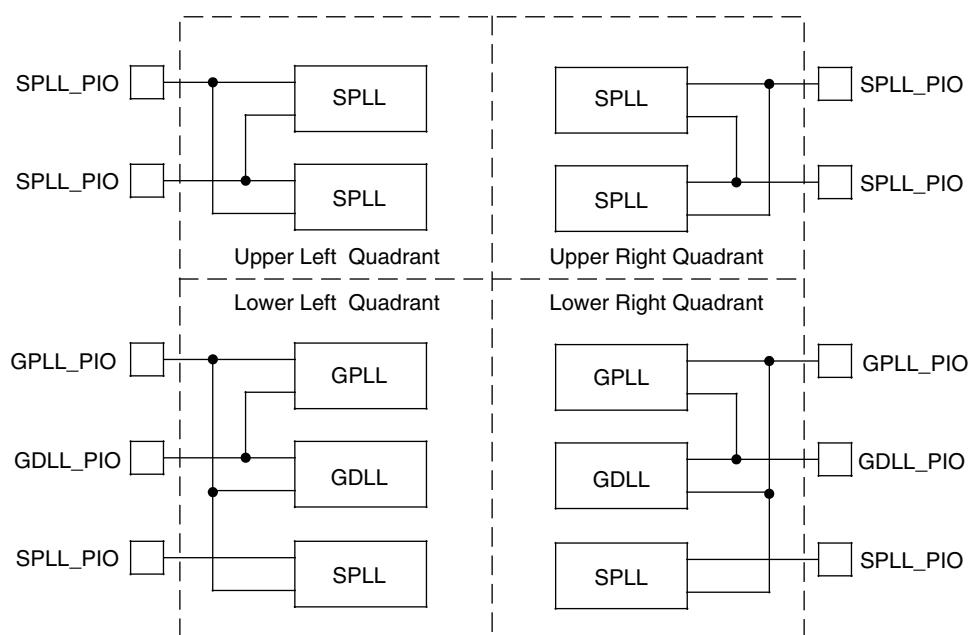
The DLLs in the LatticeECP2/M are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLLs and PLLs.

For further information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

GPLL/SPLL/GDLL PIO Input Pin Connections (LatticeECP2M Family Only)

All LatticeECP2M devices contain two GDLLs, two GPLLs and six SPLLs, arranged in quadrants as shown in Figure 2-8. In the LatticeECP2M devices GPLLs, SPLLs and GDLLs share their input pins. Figure 2-8 shows the sharing of SPLLs input pin connections in the upper two quadrants and the sharing of GDLL, GPLL and SPLL input pin connections in the lower two quadrants.

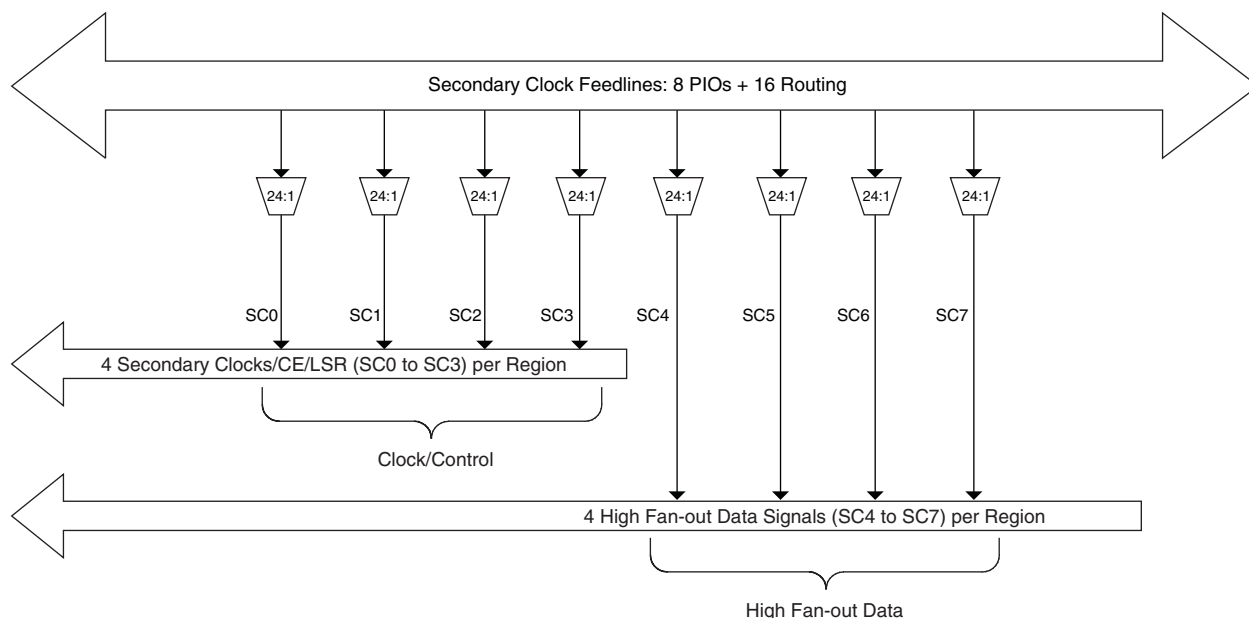
Figure 2-8. Sharing of PIO Pins by GPLL, SPLL and GDLL in LatticeECP2M Devices



Clock Dividers

LatticeECP2/M devices have two clock dividers, one on the left side and one on the right side of the device. These are intended to generate a slower-speed system clock from a high-speed edge clock. The block operates in a $\div 2$, $\div 4$ or $\div 8$ mode and maintains a known phase relationship between the divided down clock and the high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PLL/DLL outputs, DLL-DELA delay blocks, routing or from an external clock input. The clock divider outputs serve as primary clock sources and feed into the clock distribution network. The Reset (RST) control signal resets input and synchronously forces all outputs to low. The RELEASE signal releases outputs synchronously to the input clock. For further information about clock dividers, please see the list of additional technical documentation at the end of this data sheet. Figure 2-9 shows the clock divider connections.

Figure 2-16. Secondary Clock Selection

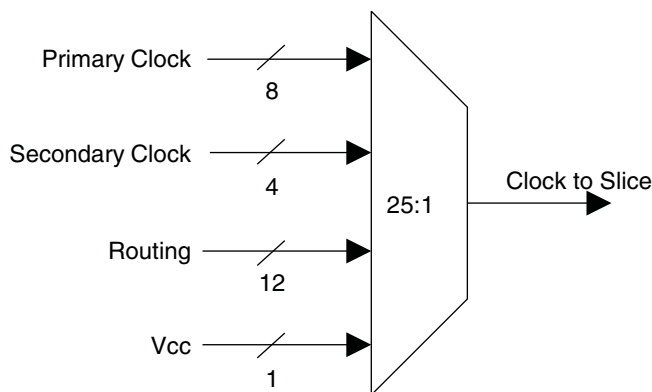


Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection





LatticeECP2/M Family Data Sheet

DC and Switching Characteristics

September 2013

Data Sheet DS1006

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC} -0.5 to 1.32V

Supply Voltage V_{CCAUX} -0.5 to 3.75V

Supply Voltage V_{CCJ} -0.5 to 3.75V

Output Supply Voltage V_{CCIO} -0.5 to 3.75V

Input or I/O Tristate Voltage Applied⁴ -0.5 to 3.75V

Storage Temperature (Ambient) -65 to 150°C

Junction Temperature (T_j) +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

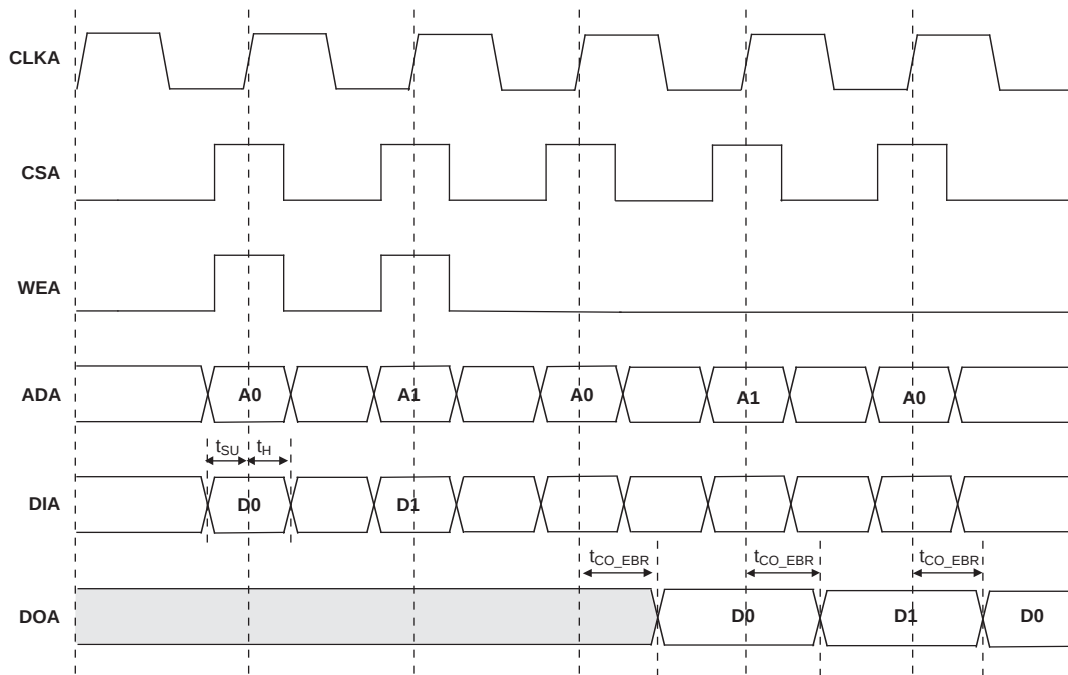
Symbol	Parameter	Min.	Max.	Units
$V_{CC}^{1, 4, 5}$	Core Supply Voltage	1.14	1.26	V
$V_{CCAUX}^{1, 3, 4, 5}$	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
$V_{CCIO}^{1, 2, 4}$	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCR}^6	Receive Power Supply	1.14	1.26	V
V_{CCT}^6	Transmit Power Supply	1.14	1.26	V

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35 V_{CC}$	$0.65 V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3 V_{CCIO}$	$0.5 V_{CCIO}$	3.6	$0.1 V_{CCIO}$	$0.9 V_{CCIO}$	1.5	-0.5
SSTL3 Class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 Class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 Class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3							

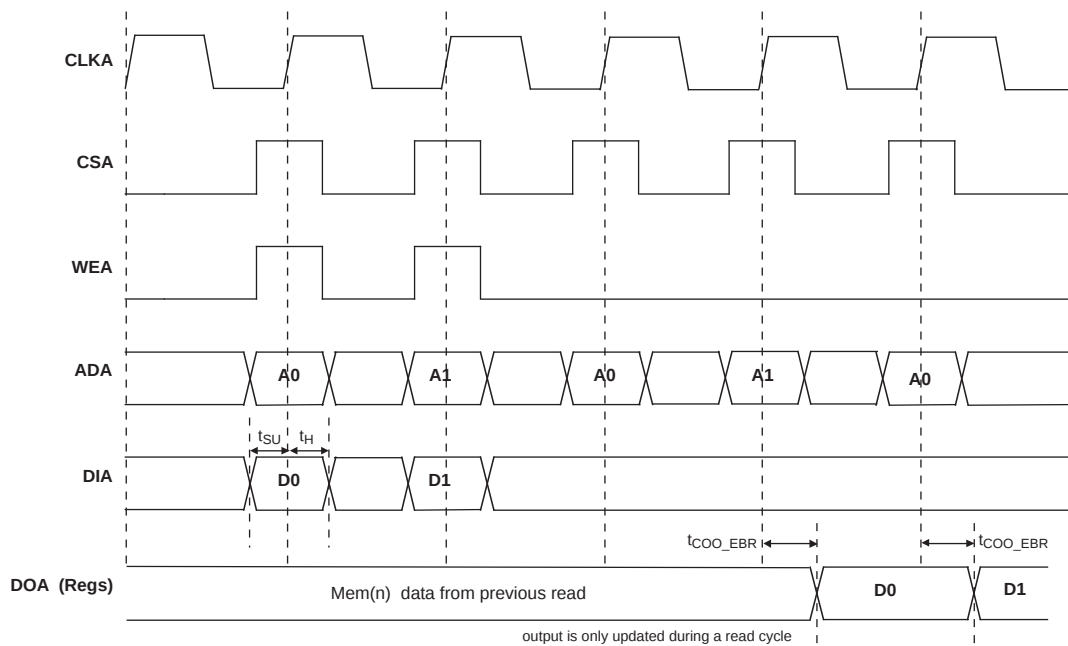
Timing Diagrams

Figure 3-9. Read/Write Mode (Normal)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

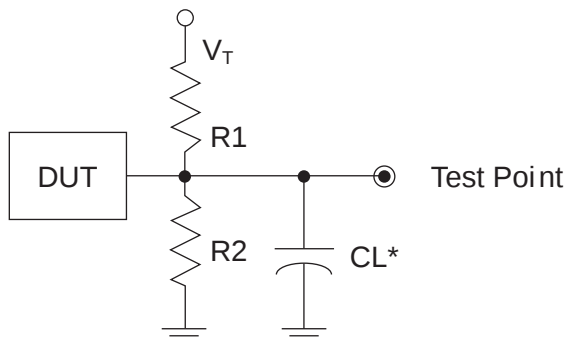
Figure 3-10. Read/Write Mode with Input and Output Registers



Switching Test Conditions

Figure 3-22 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-19.

Figure 3-22. Output Test Load, LVTTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-19. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	R ₁	R ₂	C _L	Timing Ref.	V _T
LVTTTL and other LVCMOS settings (L -> H, H -> L)	∞	∞	0pF	LVCMOS 3.3 = 1.5V	—
				LVCMOS 2.5 = V _{CCIO} /2	—
				LVCMOS 1.8 = V _{CCIO} /2	—
				LVCMOS 1.5 = V _{CCIO} /2	—
				LVCMOS 1.2 = V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z -> H)	∞	1M Ω		V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z -> L)	1M Ω	∞		V _{CCIO} /2	V _{CCIO}
LVCMOS 2.5 I/O (H -> Z)	∞	100		V _{OH} - 0.10	—
LVCMOS 2.5 I/O (L -> Z)	100	∞		V _{OL} + 0.10	V _{CCIO}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
91	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	
92	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
94	VCC	-			VCC	-			
95	GND	-			GND	-			
96	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	
97	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C	
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T	
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*	
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*	
102	VCC	-			VCC	-			
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C	
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T	
105	GND	-			GND	-			
106	VCCIO2	2			VCCIO2	2			
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C	
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T	
111	PT26B	1		C	PT54B	1		C	
112	PT26A	1		T	PT54A	1		T	
113	PT24B	1		C	PT52B	1		C	
114	PT24A	1		T	PT52A	1		T	
115	PT22B	1		C	PT50B	1		C	
116	PT22A	1		T	PT50A	1		T	
117	VCCIO1	1			VCCIO1	1			
118	PT20B	1		C	PT48B	1		C	
119	PT20A	1		T	PT48A	1		T	
120	GND	-			GND	-			
121	PT18B	1		C					

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO6	-			GNDIO6	-		
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C
GND	GNDIO6	-			GNDIO6	-		
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*
N4	TDI	-			TDI	-		
M4	TCK	-			TCK	-		
P3	TDO	-			TDO	-		
N3	TMS	-			TMS	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
K6	NC	-			PB3A	5	BDQ6	
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
R3	NC	-			PB5A	5	BDQ6	T
P4	NC	-			PB5B	5	BDQ6	C
-	-	-			VCCIO	5		
-	-	-			GNDIO5	5		
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T
VCCIO								

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W19	CFG2	8			CFG2	8		
V19	CFG1	8			CFG1	8		
V20	PROGRAMN	8			PROGRAMN	8		
W20	CFG0	8			CFG0	8		
U22	PR28B	8	D1	C	PR42B	8	D1	C
V22	INITN	8			INITN	8		
R16	PR30B	8	WRITEN	C	PR44B	8	WRITEN	C
GNDIO	GNDIO8	-			GNDIO8	-		
W22	CCLK	8			CCLK	8		
R17	PR30A	8	CS1N	T	PR44A	8	CS1N	T
V21	DONE	8			DONE	8		
VCCIO	VCCIO8	8			VCCIO8	8		
U19	PR29B	8	CSN	C	PR43B	8	CSN	C
T17	PR26B	8	D5	C	PR40B	8	D5	C
U20	PR29A	8	D0/SPIFASTN	T	PR43A	8	D0/SPIFASTN	T
U21	PR28A	8	D2	T	PR42A	8	D2	T
GNDIO	GNDIO8	-			GNDIO8	-		
T18	PR26A	8	D6	T	PR40A	8	D6	T
T20	PR27B	8	D3	C	PR41B	8	D3	C
T21	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C
T19	PR27A	8	D4	T	PR41A	8	D4	T
VCCIO	VCCIO8	8			VCCIO8	8		
T22	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T
R18	PR24B	8	DOUT/CSON	C	PR38B	8	DOUT/CSON	C
R19	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T
-	-	-			VCCIO3	3		
GNDIO	GNDIO3	-			GNDIO3	-		
P18	PR22B	3		C (LVDS)*	PR32B	3	RDQ34	C (LVDS)*
R22	PR23B	3		C	PR33B	3	RDQ34	C
P19	PR22A	3		T (LVDS)*	PR32A	3	RDQ34	T (LVDS)*
R21	PR23A	3		T	PR33A	3	RDQ34	T
VCCIO	VCCIO3	3			VCCIO3	3		
R20	PR21B	3	RLM0_GPLL_C_FB_A	C	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
P22	PR21A	3	RLM0_GPLLT_FB_A	T	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
P21	PR20B							

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E4	PL2A	7	VREF2_7/LDQ6	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*
E5	PL2B	7	VREF1_7/LDQ6	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO7	-			GNDIO7	-		
GNDIO	GNDIO7	-			VCCIO	7		
E3	PL10A	7	LDQ14	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*
F3	PL10B	7	LDQ14	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*
F4	PL11A	7	LDQ14	T	PL13A	7	LDQ16	T
F5	PL11B	7	LDQ14	C	PL13B	7	LDQ16	C
E2	PL12A	7	LDQ14	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*
VCCIO	VCCIO7	7			VCCIO	7		
E1	PL12B	7	LDQ14	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*
G6	PL13A	7	LDQ14	T	PL15A	7	LDQ16	T
G7	PL13B	7	LDQ14	C	PL15B	7	LDQ16	C
H4	PL14A	7	LDQS14	T (LVDS)*	PL16A	7	LDQS16	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO7	-		
H5	PL14B	7	LDQ14	C (LVDS)*	PL16B	7	LDQ16	C (LVDS)*
F1	PL15A	7	LDQ14	T	PL17A	7	LDQ16	T
F2	PL15B	7	LDQ14	C	PL17B	7	LDQ16	C
VCCIO	VCCIO7	7			VCCIO	7		
G3	PL16A	7	LDQ14	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*
G4	PL16B	7	LDQ14	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*
G1	PL17A	7	LDQ14	T	PL19A	7	LDQ16	T
G2	PL17B	7	LDQ14	C	PL19B	7	LDQ16	C
GNDIO	GNDIO7	-			GNDIO7	-		
-	-	-			VCCIO	7		
H6	NC	-			PL25A	7	LUM0_SPLLT_IN_A/LDQ24	T
-	-	-			VCCIO	7		
J6	NC	-			PL25B	7	LUM0_SPLLC_IN_A/LDQ24	C
H3	NC	-			PL26A	7	LUM0_SPLLT_FB_A/LDQ24	T
H2	NC	-			PL26B	7	LUM0_SPLLC_FB_A/LDQ24	C
-	-	-			GNDIO7	-		
-	-	-			VCCIO	7		
H1								

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U24	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLL_C_IN_A**/RDQ48	C (LVDS)*	
U25	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLL_T_IN_A**/RDQ48	T (LVDS)*	
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
P18	VCC	3			VCCPLL	3			
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C	
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T	
GND	GNDIO3	-			GNDIO3	-			
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*	
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*	
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C	
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T	
VCCIO	VCCIO3	3			VCCIO3	3			
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*	
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*	
R22	NC	-			PR38B	3	RDQ39	C	
GND	GNDIO3	-			GNDIO3	-			
T21	NC	-			PR38A	3	RDQ39	T	
P26	NC	-			NC	-			
P25	NC	-			NC	-			
R24	NC	-			NC	-			
VCCIO	VCCIO3	3			VCCIO3	3			
R23	NC	-			NC	-			
P20	NC	-			NC	-			
R19	NC	-			NC	-			
P21	NC	-			PR34B	3	RDQ31	C	
GND	GNDIO3	-			GNDIO3	-			
P19	NC	-			PR34A	3	RDQ31	T	
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*	
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*	
N22									

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB38B	5	BDQ42	C	PB47B	5	BDQ51	C	
AE10	PB39A	5	BDQ42	T	PB48A	5	BDQ51	T	
AF10	PB39B	5	BDQ42	C	PB48B	5	BDQ51	C	
W14	PB40A	5	BDQ42	T	PB49A	5	BDQ51	T	
AB13	PB40B	5	BDQ42	C	PB49B	5	BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y14	PB41A	5	BDQ42	T	PB50A	5	BDQ51	T	
AB14	PB41B	5	BDQ42	C	PB50B	5	BDQ51	C	
GND	GNDIO5	-			GNDIO5	-			
AE11	PB42A	5	BDQS42	T	PB51A	5	BDQS51	T	
AF11	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C	
AD14	PB43A	5	BDQ42	T	PB52A	5	BDQ51	T	
AA15	PB43B	5	BDQ42	C	PB52B	5	BDQ51	C	
AE12	PB44A	5	PCLKT5_0/BDQ42	T	PB53A	5	PCLKT5_0/BDQ51	T	
AF12	PB44B	5	PCLKC5_0/BDQ42	C	PB53B	5	PCLKC5_0/BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GND	GNDIO5	-			GNDIO5	-			
AD15	PB49A	4	PCLKT4_0/BDQ51	T	PB58A	4	PCLKT4_0/BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AC15	PB49B	4	PCLKC4_0/BDQ51	C	PB58B	4	PCLKC4_0/BDQ60	C	
AE13	PB50A	4	BDQ51	T	PB59A	4	BDQ60	T	
AF13	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
AB17	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T	
GND	GNDIO4	-			GNDIO4	-			
Y15	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C	
AE14	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AF14	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA16	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT75B	1		C	PT93B	1		C
D20	PT75A	1		T	PT93A	1		T
A22	PT74B	1		C	PT92B	1		C
A21	PT74A	1		T	PT92A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	PT71B	1		C	PT85B	1		C
C19	PT71A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B21	PT70B	1		C	PT79B	1		C
B20	PT70A	1		T	PT79A	1		T
D19	PT69B	1		C	PT78B	1		C
B19	PT69A	1		T	PT78A	1		T
GND	GNDIO1	-			GNDIO1	-		
G17	PT68B	1		C	PT77B	1		C
E18	PT68A	1		T	PT77A	1		T
G19	PT67B	1		C	PT76B	1		C
F17	PT67A	1		T	PT76A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A20	PT66B	1		C	PT75B	1		C
A19	PT66A	1		T	PT75A	1		T
E17	PT65B	1		C	PT74B	1		C
D18	PT65A	1		T	PT74A	1		T
B18	PT64B	1		C	PT73B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT64A	1		T	PT73A	1		T
E16	PT63B	1		C	PT72B	1		C
G16	PT63A	1		T	PT72A	1		T
F16	PT62B	1		C	PT71B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT62A	1		T	PT71A	1		T
A17	PT61B	1		C	PT70B	1		C
B17	PT61A	1		T	PT70A	1		T
C18	PT60B	1		C	PT69B	1		C
B16	PT60A	1		T	PT69A	1		T
C17	PT59B	1		C	PT68B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT59A	1		T</				

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T	
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T	
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C	
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T	
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C	
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T	
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T	
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C	
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T	
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C	
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T	
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T	
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AH18	LRC_SQ_VCCR3	13			LRC_SQ_VCCR3	13			
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T	
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13			
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C	
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13			
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T	
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_V				

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A21	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			
A22	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T	
C21	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12			
B19	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C	
B18	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12			
A19	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T	
C18	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12			
D23	PT73B	1		C	PT82B	1		C	
GNDIO	GNDIO1	-			GNDIO1	-			
E21	PT73A	1		T	PT82A	1		T	
D26	PT72B	1		C	PT81B	1		C	
E26	PT72A	1		T	PT81A	1		T	
E23	PT71B	1		C	PT80B	1		C	
-	-	-			VCCIO1	1			
G22	PT71A	1		T	PT80A	1		T	
VCCIO	VCCIO1	1			-	-			
D22	PT70B	1		C	PT79B	1		C	
F21	PT70A	1		T	PT79A	1		T	
G18	PT69B	1		C	PT78B	1		C	
H18	PT69A	1		T	PT78A	1		T	
D20	PT68B	1		C	PT77B	1		C	
GNDIO	GNDIO1	-			GNDIO1	-			
D21	PT68A	1		T	PT77A	1		T	
E20	PT67B	1		C	PT76B	1		C	
E19	PT67A	1		T	PT76A	1		T	
D19	PT66B	1		C	PT75B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
E18	PT66A	1		T	PT75A	1		T	
D18	PT65B	1		C	PT74B	1		C	
C17	PT65A	1		T	PT74A	1		T	
A17	PT64B	1		C	PT73B	1		C	
B17	PT64A	1		T	PT73A	1		T	
GNDIO	GNDIO1	-							

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7			VCCIO7	7		
F4	PL9A	7	VREF2_7	T	PL9A	7	VREF2_7	T
F3	PL9B	7	VREF1_7	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
E1	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
E2	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
K9	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
H7	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
VCCIO	VCCIO7	7			VCCIO7	7		
F1	PL13A	7	LDQ15	T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F2	PL13B	7	LDQ15	C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
J8	PL14A	7	LDQ15	T	PL14A	7	LDQ15	T
H6	PL14B	7	LDQ15	C	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	PL15A	7	LDQS15	T (LVDS)*	PL15A	7	LDQS15	T (LVDS)*
G1	PL15B	7	LDQ15	C (LVDS)*	PL15B	7	LDQ15	C (LVDS)*
J7	PL16A	7	LDQ15	T	PL16A	7	LDQ15	T
VCCIO	VCCIO7	7			VCCIO7	7		
L8	PL16B	7	LDQ15	C	PL16B	7	LDQ15	C
L9	PL17A	7	LDQ15	T (LVDS)*	PL17A	7	LDQ15	T (LVDS)*
L10	PL17B	7	LDQ15	C (LVDS)*	PL17B	7	LDQ15	C (LVDS)*
H5	PL18A	7	LDQ15	T	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-			GNDIO7	-		
J6	PL18B	7	LDQ15	C	PL18B	7	LDQ15	C
H2	NC	-			PL19A	7	LDQ23	T (LVDS)*
H1	NC	-			PL19B	7	LDQ23	C (LVDS)*
G5	NC	-			PL20A	7	LDQ23	T
G6	NC	-			PL20B	7	LDQ23	C
M9	NC	-			PL21A	7	LDQ23	T (LVDS)*
-	-	-			VCCIO7	7		
M10	NC	-			PL21B	7	LDQ23	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E5	ULC_SQ_REFCLKN	11		C	ULC_SQ_REFCLKN	11		C
D5	ULC_SQ_REFCLKP	11		T	ULC_SQ_REFCLKP	11		T
D6	ULC_SQ_VCCP	11			ULC_SQ_VCCP	11		
C5	ULC_SQ_HDINP2	11		T	ULC_SQ_HDINP2	11		T
D4	ULC_SQ_VCCIB2	11			ULC_SQ_VCCIB2	11		
C4	ULC_SQ_HDINN2	11		C	ULC_SQ_HDINN2	11		C
B5	ULC_SQ_VCCRX2	11			ULC_SQ_VCCRX2	11		
A5	ULC_SQ_HDOUTP2	11		T	ULC_SQ_HDOUTP2	11		T
D3	ULC_SQ_VCCOB2	11			ULC_SQ_VCCOB2	11		
A4	ULC_SQ_HDOUTN2	11		C	ULC_SQ_HDOUTN2	11		C
B4	ULC_SQ_VCCTX2	11			ULC_SQ_VCCTX2	11		
A3	ULC_SQ_HDOUTN3	11		C	ULC_SQ_HDOUTN3	11		C
C1	ULC_SQ_VCCOB3	11			ULC_SQ_VCCOB3	11		
A2	ULC_SQ_HDOUTP3	11		T	ULC_SQ_HDOUTP3	11		T
B3	ULC_SQ_VCCTX3	11			ULC_SQ_VCCTX3	11		
C3	ULC_SQ_HDINN3	11		C	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11			ULC_SQ_VCCIB3	11		
C2	ULC_SQ_HDINP3	11		T	ULC_SQ_HDINP3	11		T
B2	ULC_SQ_VCCRX3	11			ULC_SQ_VCCRX3	11		
AA13	VCC	-			VCC	-		
AA14	VCC	-			VCC	-		
AA15	VCC	-			VCC	-		
AA16	VCC	-			VCC	-		
AA17	VCC	-			VCC	-		
AA18	VCC	-			VCC	-		
AA19	VCC	-			VCC	-		
AA20	VCC	-			VCC	-		
AA21	VCC	-			VCC	-		
AA22	VCC	-			VCC	-		
AB14	VCC	-			VCC	-		
AB15	VCC	-			VCC	-		
AB20	VCC	-			VCC	-		
AB21	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N15	VCC	-			VCC	-		
N20								

LatticeECP2 S-Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5T144C	90	1.2V	-5	TQFP	144	Com	6
LFE2-6SE-6T144C	90	1.2V	-6	TQFP	144	Com	6
LFE2-6SE-7T144C	90	1.2V	-7	TQFP	144	Com	6
LFE2-6SE-5F256C	190	1.2V	-5	fpBGA	256	Com	6
LFE2-6SE-6F256C	190	1.2V	-6	fpBGA	256	Com	6
LFE2-6SE-7F256C	190	1.2V	-7	fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5T144C	93	1.2V	-5	TQFP	144	Com	12
LFE2-12SE-6T144C	93	1.2V	-6	TQFP	144	Com	12
LFE2-12SE-7T144C	93	1.2V	-7	TQFP	144	Com	12
LFE2-12SE-5Q208C	131	1.2V	-5	PQFP	208	Com	12
LFE2-12SE-6Q208C	131	1.2V	-6	PQFP	208	Com	12
LFE2-12SE-7Q208C	131	1.2V	-7	PQFP	208	Com	12
LFE2-12SE-5F256C	193	1.2V	-5	fpBGA	256	Com	12
LFE2-12SE-6F256C	193	1.2V	-6	fpBGA	256	Com	12
LFE2-12SE-7F256C	193	1.2V	-7	fpBGA	256	Com	12
LFE2-12SE-5F484C	297	1.2V	-5	fpBGA	484	Com	12
LFE2-12SE-6F484C	297	1.2V	-6	fpBGA	484	Com	12
LFE2-12SE-7F484C	297	1.2V	-7	fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5Q208C	131	1.2V	-5	PQFP	208	Com	20
LFE2-20SE-6Q208C	131	1.2V	-6	PQFP	208	Com	20
LFE2-20SE-7Q208C	131	1.2V	-7	PQFP	208	Com	20
LFE2-20SE-5F256C	193	1.2V	-5	fpBGA	256	Com	20
LFE2-20SE-6F256C	193	1.2V	-6	fpBGA	256	Com	20
LFE2-20SE-7F256C	193	1.2V	-7	fpBGA	256	Com	20
LFE2-20SE-5F484C	331	1.2V	-5	fpBGA	484	Com	20
LFE2-20SE-6F484C	331	1.2V	-6	fpBGA	484	Com	20
LFE2-20SE-7F484C	331	1.2V	-7	fpBGA	484	Com	20
LFE2-20SE-5F672C	402	1.2V	-5	fpBGA	672		